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Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (TYP.)	
100	0.0260 at V _{GS} = 10 V	35	31 nC	
100	0.0375 at V _{GS} = 7 V	31	31110	



Top View

FEATURES

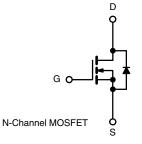
- TrenchFET® power MOSFET
- 100 % UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHSCOMPLIANT

APPLICATIONS

· Primary side switch



Ordering Information:

SUD35N10-26P-E3 (lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	100	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		35	
Continuous Dusin Comment /T 475 °C\	T _C = 70 °C		32	
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	12 b, c	
	T _A = 70 °C		10 b, c	
Pulsed Drain Current		I _{DM}	40	A
Continuous Source-Drain Diode Current	T _C = 25 °C		50 e	
	T _A = 25 °C	I _S	6.9 b, c	
Avalanche Current Pulse	alanche Current Pulse		33	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	55	mJ
	T _C = 25 °C		83	
Maximum Power Dissipation	T _C = 70 °C		58	W
	T _A = 25 °C	P _D	8.3 b, c	
	T _A = 70 °C		5.8 b, c	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient b, d	t ≤ 10 s	R_{thJA}	15	18	°C/W
Maximum Junction-to-Case	Steady State	R_{thJC}	1.5	1.8	0/00

Notes

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under steady state conditions is 50 °C/W.
- e. Calculated based on maximum junction temperature. Package limitation current is 50 A.



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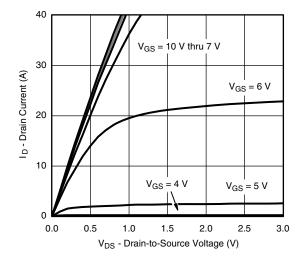
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	165	-	mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$	-	-11	-	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5	-	4.4	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	Inno	V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	μΑ
Zero date voltage Drain Guirent	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α
Drain-Source On-State Resistance ^a	B _{DO(})	$V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	-	0.0210	0.0260	Ω
Brain Course on State Resistance	ain-Source On-State Resistance a R _{DS(on)} V _{GS} = 7 V, I _D = 8 A		-	0.0285	0.0375	32
Forward Transconductance a	9fs	$V_{DS} = 15 \text{ V}, I_D = 12 \text{ A}$	-	25	-	S
Dynamic ^b						
Input Capacitance	C _{iss}		-	2000	-	pF
Output Capacitance	Coss	$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	180	-	
Reverse Transfer Capacitance	C _{rss}		-	60	-	
Total Gate Charge	Qg		-	31	47	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	-	10	-	
Gate-Drain Charge	Q _{gd}		-	9	-	
Gate Resistance	R_g	f = 1 MHz	-	1.5	-	Ω
Turn-On Delay Time	t _{d(on)}		-	10	15	
Rise Time	t _r	$V_{DD} = 50 \text{ V}, R_1 = 5 \Omega$	-	10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω	-	15	25	ns
Fall Time	t _f		-	10	15	
Drain-Source Body Diode Characteristic	S		L		L	
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	50	_
Pulse Diode Forward Current ^a	I _{SM}			-	40	A
Body Diode Voltage	V _{SD}	I _S = 10 A	-	0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}		-	50	75	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	100	150	nC
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	38	-	
Reverse Recovery Rise Time	t _b	┥ '		12	_	ns

Note

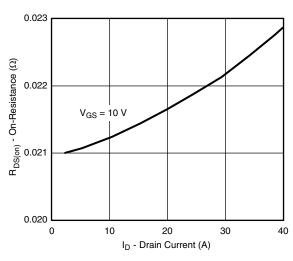
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

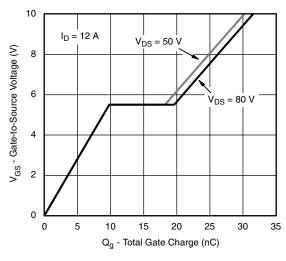




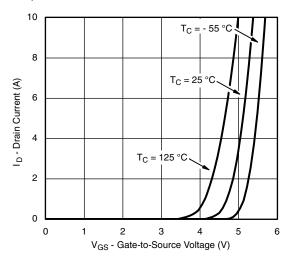
Output Characteristics



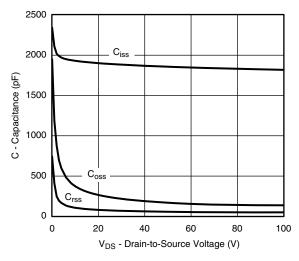
On-Resistance vs. Drain Current



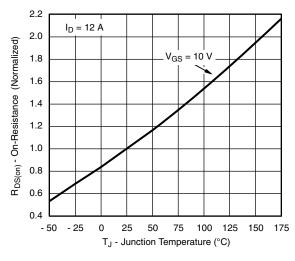
Gate Charge



Transfer Characteristics

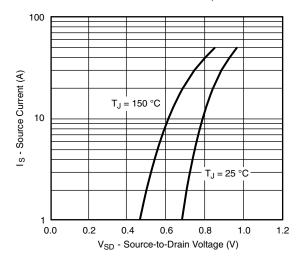


Capacitance

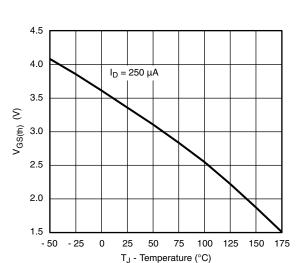


On-Resistance vs. Junction Temperature

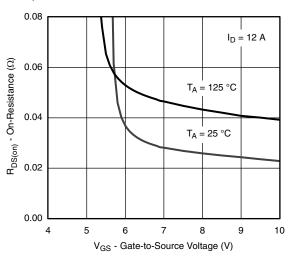




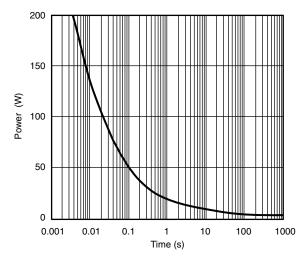
Source-Drain Diode Forward Voltage



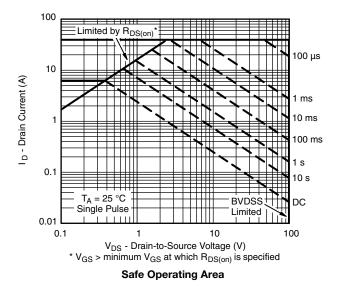
Threshold Voltage



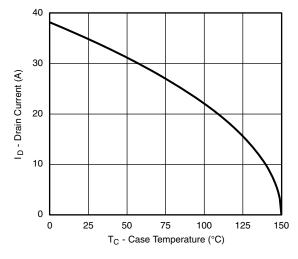
R_{DS(on)} vs. V_{GS} vs. Temperature

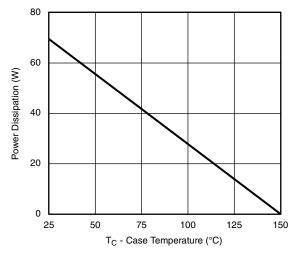


Single Pulse Power, Junction-to-Ambient









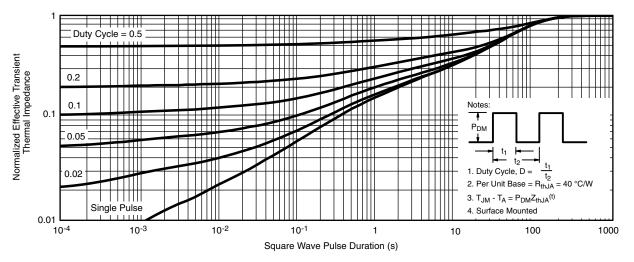
Current Derating a

Power Derating

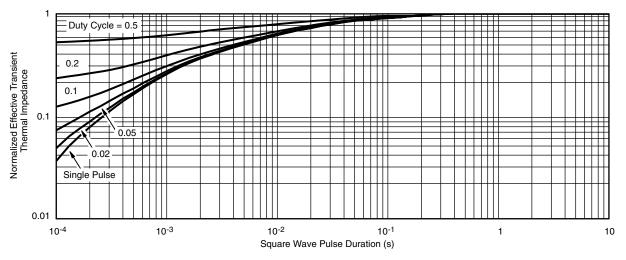
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

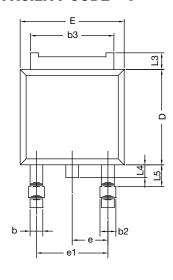
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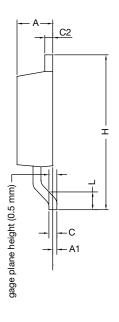
S15-1599-Rev. B, 06-Jul-15 **6** Document Number: 69796

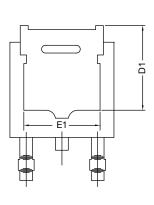


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







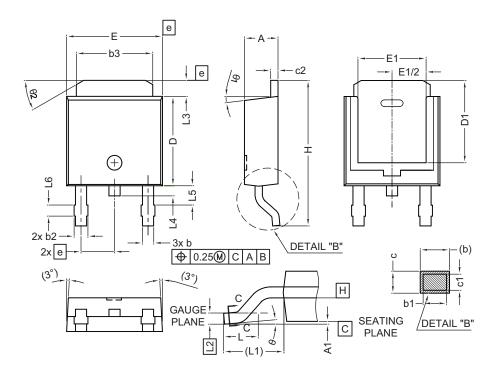
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	- 1.02		
L5	1.01 1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97 6.22		
D1	5.21 -		
Е	6.35 6.73		
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

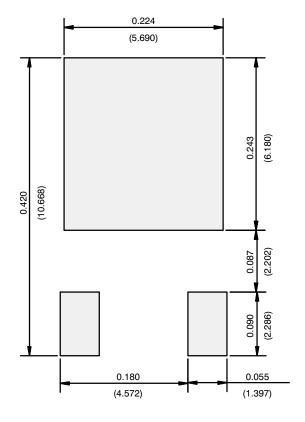
ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347

Revision: 16-Dec-2019



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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